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Part Number: [0554541970](#)
Status: **Active**
Description: 1.25mm (.049") Pitch Mi II™ System Wire-to-Board Header, Single Row, Right Angle, Lead-free, 19 Circuits

Documents:

[3D Model](#) [Product Specification PS-54596-018 \(PDF\)](#)
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)

General

Product Family	PCB Headers
Series	55454
Application	Wire-to-Board
Product Name	Mini Mi II™

Physical

Breakaway	No
Circuits (Loaded)	19
Color - Resin	Natural
Durability (mating cycles max)	30
First Mate / Last Break	No
Glow-Wire Compliant	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	Yes
Material - Plating Mating	Tin
Material - Plating Termination	Tin
Number of Rows	1
Orientation	Right Angle
PC Tail Length (in)	0.118 In
PC Tail Length (mm)	3.00 mm
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness Recommended (in)	0.062 In
PCB Thickness Recommended (mm)	1.60 mm
Packaging Type	Tray
Pitch - Mating Interface (in)	0.049 In
Pitch - Mating Interface (mm)	1.25 mm
Polarized to Mating Part	Yes
Shrouded	Fully
Stackable	No
Surface Mount Compatible (SMC)	No
Temperature Range - Operating	-40°C to +105°C
Termination Interface: Style	Through Hole

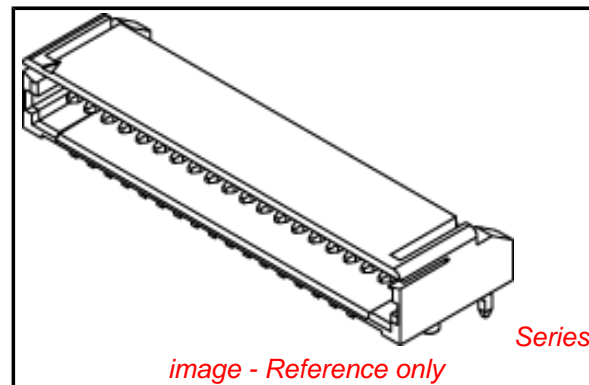
Electrical

Current - Maximum per Contact	1.5A
Voltage - Maximum	100V

Material Info

Reference - Drawing Numbers

Product Specification	PS-54596-018, RPS-54596-024
Sales Drawing	SD-55454-007



EU RoHS

ELV and RoHS Compliant
REACH SVHC
 Not Reviewed
Halogen-Free Status
 Not Reviewed

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
 For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

[55454Series](#)

Mates With

[51336](#) PBT Polyester, Glass-filled Housing.
[54596](#) PA Polyamide Housing

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番号 NO.	名称 NAME	原料 MATERIAL	数量 QT'Y	仕上げ FINISH
①	ウエハー WEFAR	ポリアミド PA	1	UL94V-0
②	ピン PIN	黄銅 BRASS	N	錫メッキ 1.0マイクロメートル以上 PRE-TINNED 1.0 MICROMETER MINIMUM 下地: ニッケルメッキ 0.5マイクロメートル以上 UNDER PLATE NICKEL 0.5 MICROMETER MINIMUM

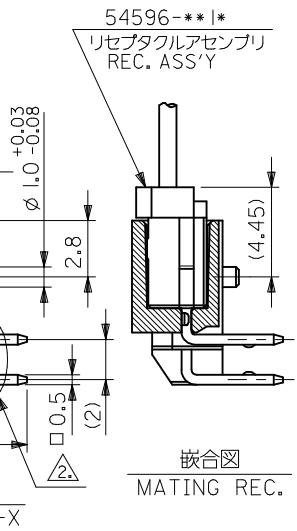
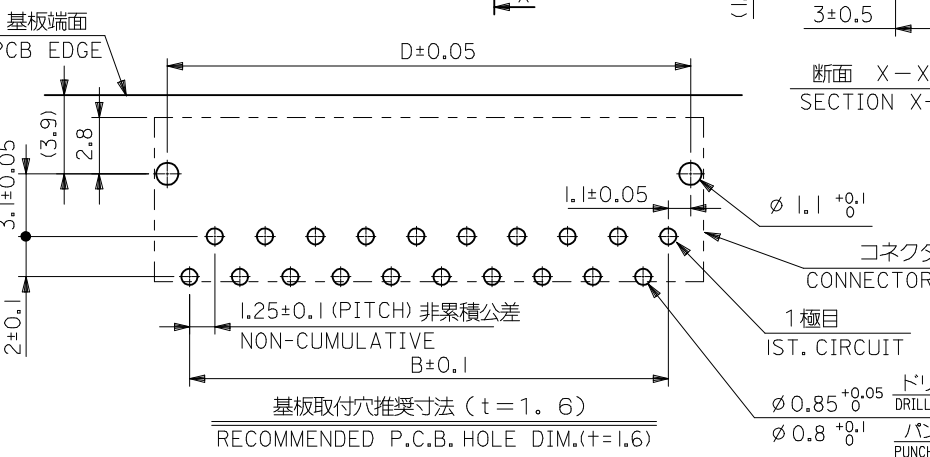
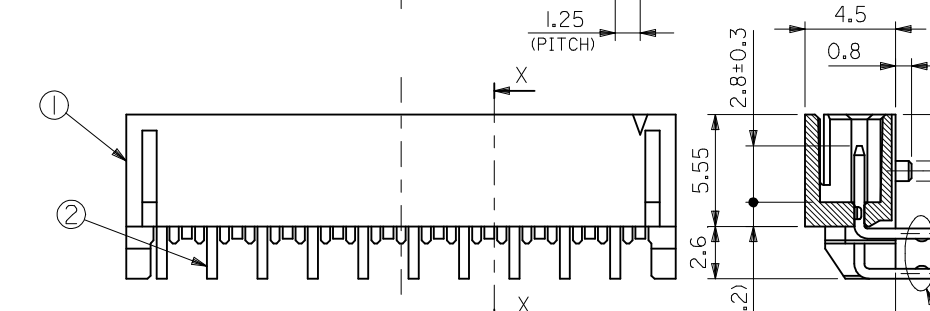
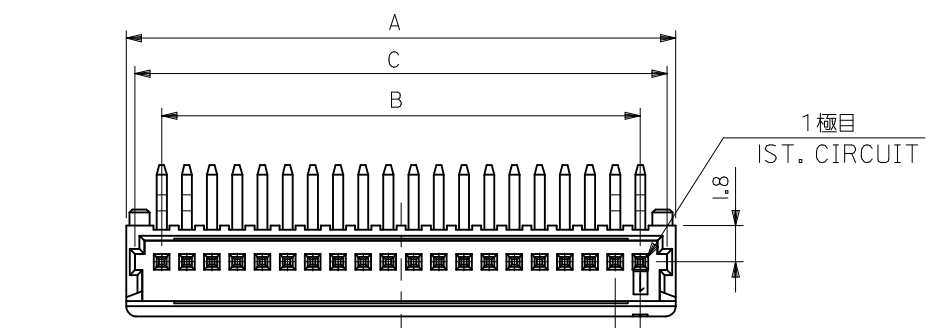
注) NOTES

- 1. 原料および仕上げ: 表参照
MATERIAL AND FINISH: SEE CHART
- △ キングは、両サイド4ピンに適用。(4極品までは、全極に適用)
TO BE APPLICABLE 4 PIN OF BOTH SIDE.
- △ 製品番号
MATERIAL NO.
55454-***7*
極数 CIRCUIT SIZE (02 ~ 20)
メッキ仕様: 無鉛 PLATING: LEAD FREE
色 COLOR
0: 自然色 NATURAL
2: 赤色 RED
3: 黄色 YELLOW

25.95	26.4	23.75	27.25	20	55454-207*
24.7	25.15	22.5	26	19	-197*
23.45	23.9	21.25	24.75	18	-187*
22.2	22.65	20	23.5	17	-177*
20.95	21.4	18.75	22.25	16	-167*
19.7	20.15	17.5	21	15	-157*
18.45	18.9	16.25	19.75	14	-147*
17.2	17.65	15	18.5	13	-137*
15.95	16.4	13.75	17.25	12	-127*
14.7	15.15	12.5	16	11	-117*
13.45	13.9	11.25	14.75	10	-107*
12.2	12.65	10	13.5	9	-097*
10.95	11.4	8.75	12.25	8	-087*
9.7	10.15	7.5	11	7	-077*
8.45	8.9	6.25	9.75	6	-067*
7.2	7.65	5	8.5	5	-057*
5.95	6.4	3.75	7.25	4	-047*
4.7	5.15	2.5	6	3	-037*
3.45	3.9	1.25	4.75	2	55454-027*

55454-***7*

D	C	B	A	極数 CIRCUIT SIZE	製品番号 MATERIAL NO.	MODEL NO.
					△ 製品番号 MATERIAL NO.	



無鉛 LEAD FREE

REVISED		GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE		DESIGN UNITS		THIRD ANGLE PROJECTION	
EC NO: J2009-1881	2009/02/05	10 UNDER	±0.2	MM ONLY		4:1		METRIC			
DRWRTSURIJOKA	2009/02/05	10 OVER 30 UNDER	±0.25	DRAWN BY DATE		TITLE		MINI M12 1-ROW R/A WAFER ASS'Y (SN)			
CHKD: THARUYAMA	2009/02/05	30 OVER	±0.3	N. YOSHIDA '03/02/12							
APPR: NUKITA	2009/02/05	ANGULAR ±3 °		CHECKED BY DATE				MOLEX INCORPORATED SD-55454-007			
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		M. YAGI '03/02/12							
A				APPROVED BY DATE		MATERIAL NO.		DOCUMENT NO.		SHEET NO.	
				Y. ITO '03/02/12		SEE TABLE		SD-55454-007		1 OF 1	
						SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			